



BAW56SRA-Q

Quad high-speed switching diodes

28 June 2022

Product data sheet

1. General description

Quad high-speed switching diodes with common anode configurations encapsulated in a leadless ultra small DFN1412-6 (SOT1268) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: $t_{rr} \leq 4$ ns
- Low leakage current
- Reverse voltage $V_R \leq 90$ V
- Low capacitance $C_d \leq 2$ pF
- Ultra small SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High-speed switching
- General-purpose switching

4. Quick reference data

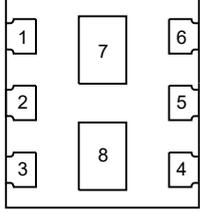
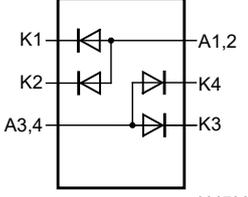
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
I_F	forward current	single diode loaded; $T_{amb} = 25$ °C	[1]	-	-	375	mA
I_R	reverse current	$V_R = 80$ V; pulsed; $T_j = 25$ °C		-	-	0.5	µA
V_F	forward voltage	$I_F = 150$ mA; $t_p \leq 300$ µs; $\delta \leq 0.02$; $T_j = 25$ °C		-	-	1.25	V
V_R	reverse voltage	$T_j = 25$ °C		-	-	90	V
t_{rr}	reverse recovery time	$I_F = 10$ mA; $I_R = 10$ mA; $R_L = 100$ Ω; $I_{R(meas)} = 1$ mA; $T_{amb} = 25$ °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 <p>Transparent top view DFN1412-6 (SOT1268)</p>	 <p>aaa-026796</p>
2	K2	cathode (diode 2)		
3	A3,4	com. anode (diodes 3, 4)		
4	K3	cathode (diode 3)		
5	K4	cathode (diode 4)		
6	A1,2	com. anode (diodes 1, 2)		
7	A1,2	com. anode (diodes 1, 2)		
8	A3,4	com. anode (diodes 3, 4)		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAW56SRA-Q	DFN1412-6	plastic, thin small outline package; no leads; 6 terminals; 1.4 mm x 1.2 mm x 0.47 mm body	SOT1268

7. Marking

Table 4. Marking codes

Type number	Marking code
BAW56SRA-Q	A2

8. Limiting values

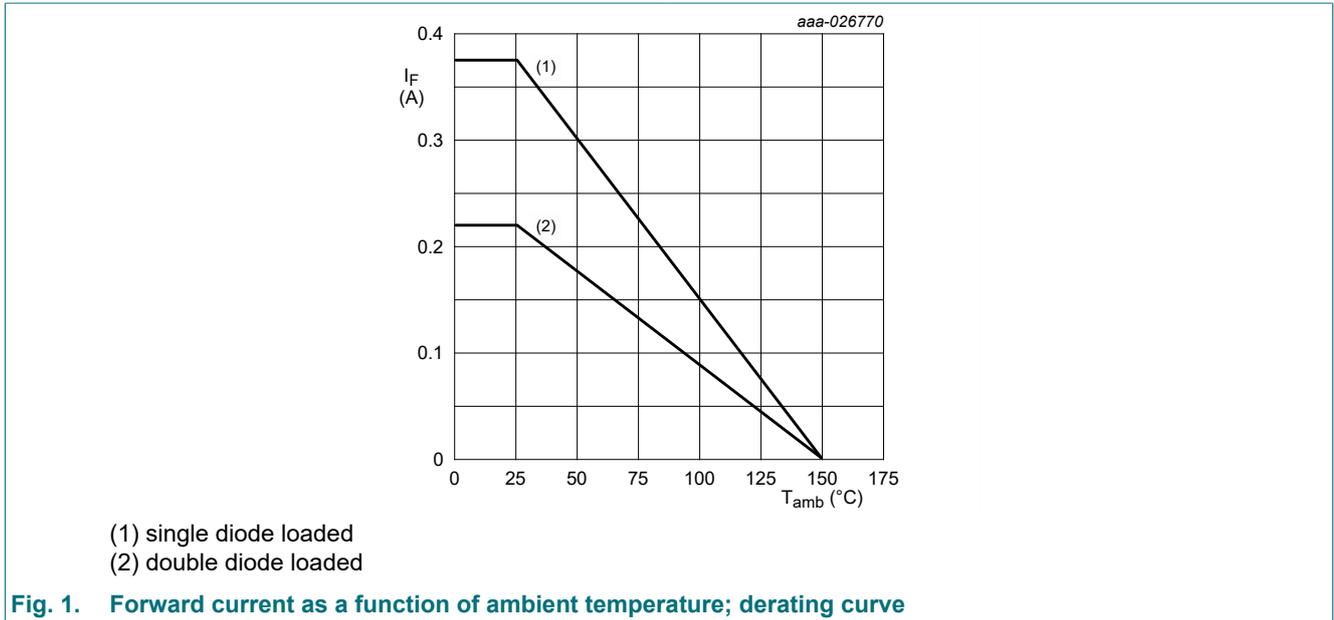
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V_R	reverse voltage	$T_j = 25\text{ °C}$		-	90	V
I_F	forward current	single diode loaded; $T_{amb} = 25\text{ °C}$	[1]	-	375	mA
		double diodes loaded; $T_{amb} = 25\text{ °C}$	[1]	-	220	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 100\text{ }\mu\text{s}$; square wave; $T_{j(init)} = 25\text{ °C}$		-	4	A
		$t_p = 1\text{ ms}$; square wave; $T_{j(init)} = 25\text{ °C}$		-	1.5	A
		$t_p = 1\text{ s}$; square wave; $T_{j(init)} = 25\text{ °C}$		-	0.5	A
I_{FRM}	repetitive peak forward current	$t_p \leq 0.5\text{ ms}$; $\delta \leq 0.25$		-	1	A
Per device; one diode loaded						
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	410	mW
			[2]	-	610	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	305	K/W
			[2]	-	-	205	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	40	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1cm².
- [3] Soldering point of anode tab.

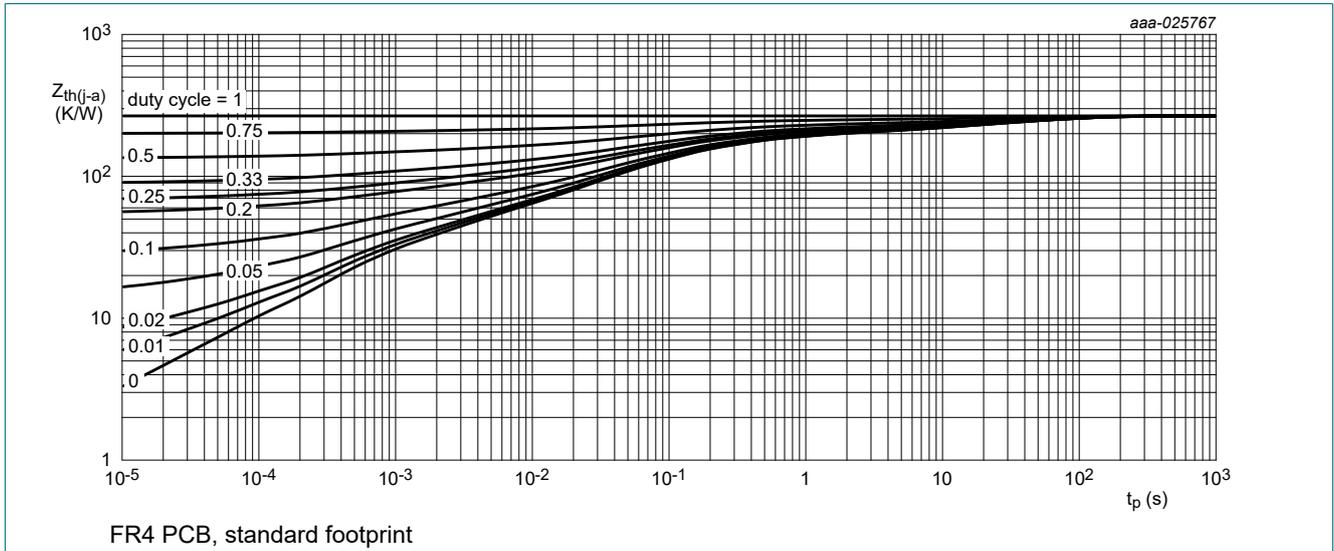


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

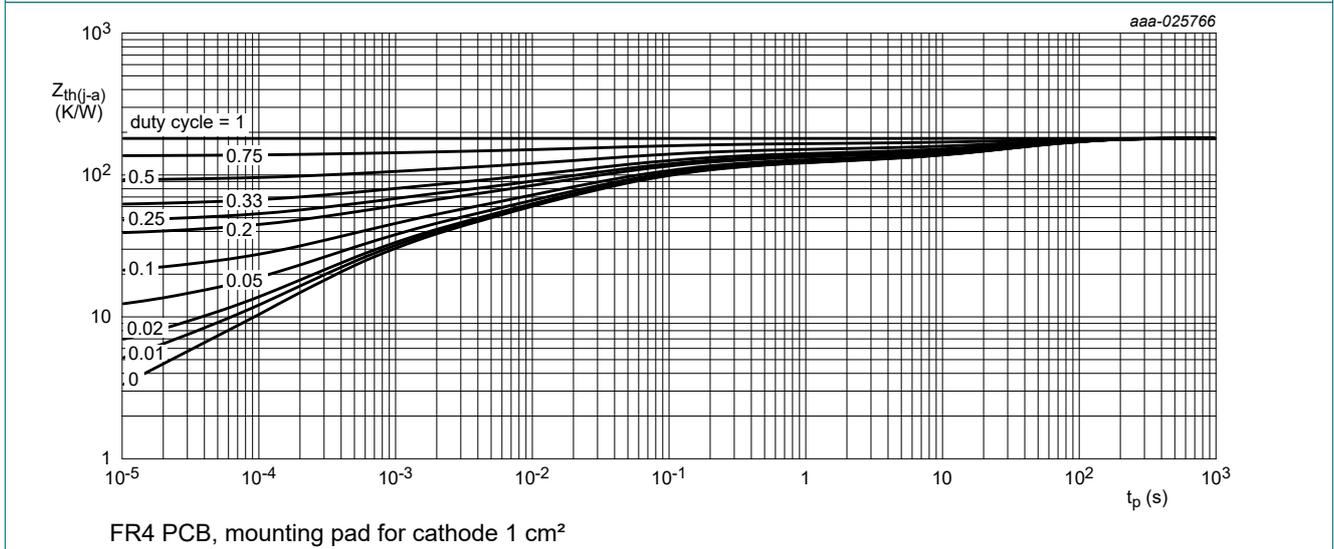
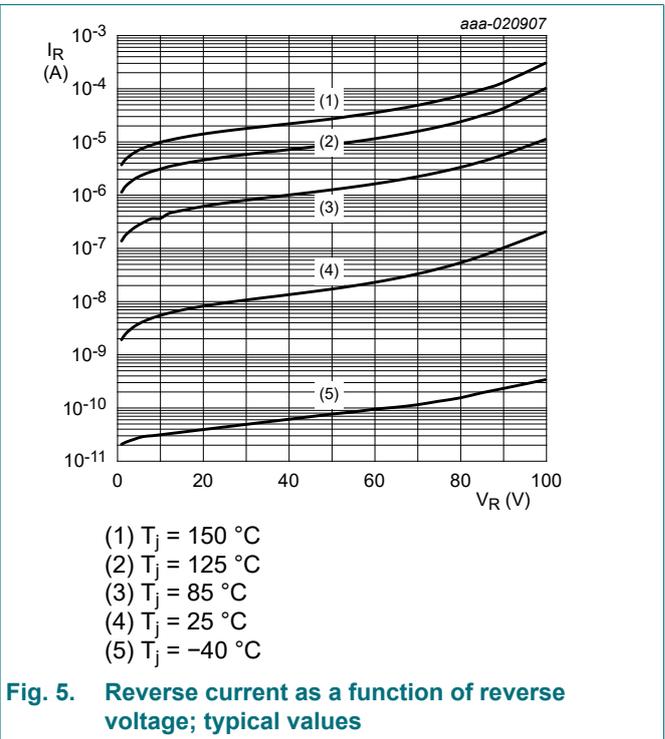
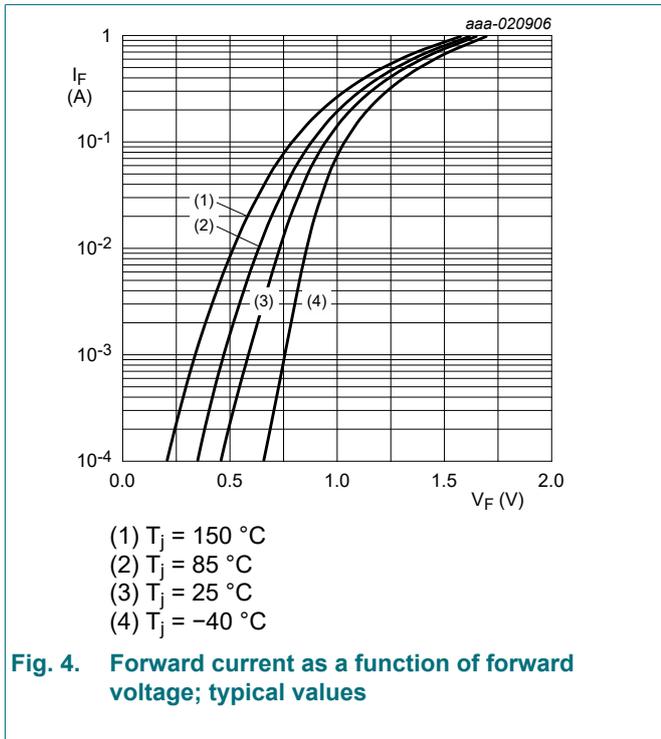


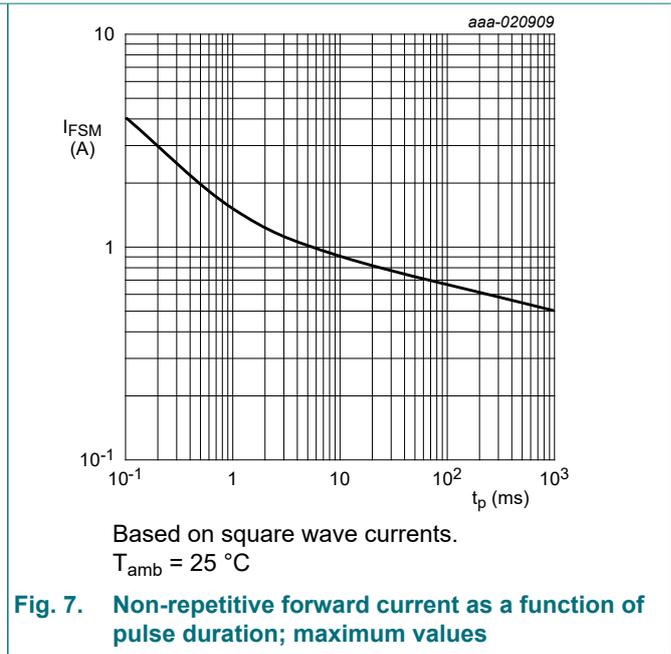
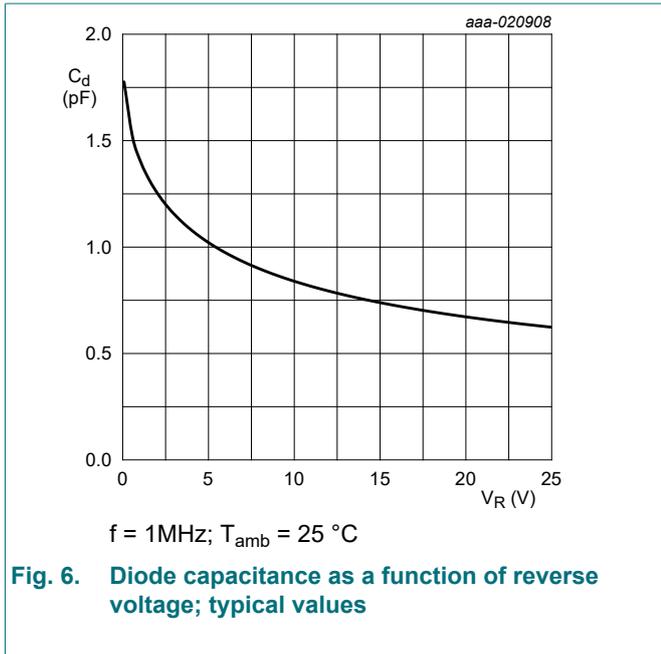
Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per diode						
V _F	forward voltage	I _F = 1 mA; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	-	715	mV
		I _F = 10 mA; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	-	855	mV
		I _F = 50 mA; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	-	1	V
		I _F = 150 mA; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	-	1.25	V
I _R	reverse current	V _R = 25 V; pulsed; T _j = 25 °C	-	-	30	nA
		V _R = 80 V; pulsed; T _j = 25 °C	-	-	0.5	μA
		V _R = 25 V; pulsed; T _j = 150 °C	-	-	30	μA
		V _R = 80 V; pulsed; T _j = 150 °C	-	-	150	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _j = 25 °C	-	-	2	pF
t _{rr}	reverse recovery time	I _F = 10 mA; I _R = 10 mA; R _L = 100 Ω; I _{R(meas)} = 1 mA; T _{amb} = 25 °C	-	-	4	ns
V _{FRM}	peak forward recovery voltage	I _F = 10 mA; t _r = 20 ns	-	-	1.75	V





11. Test information

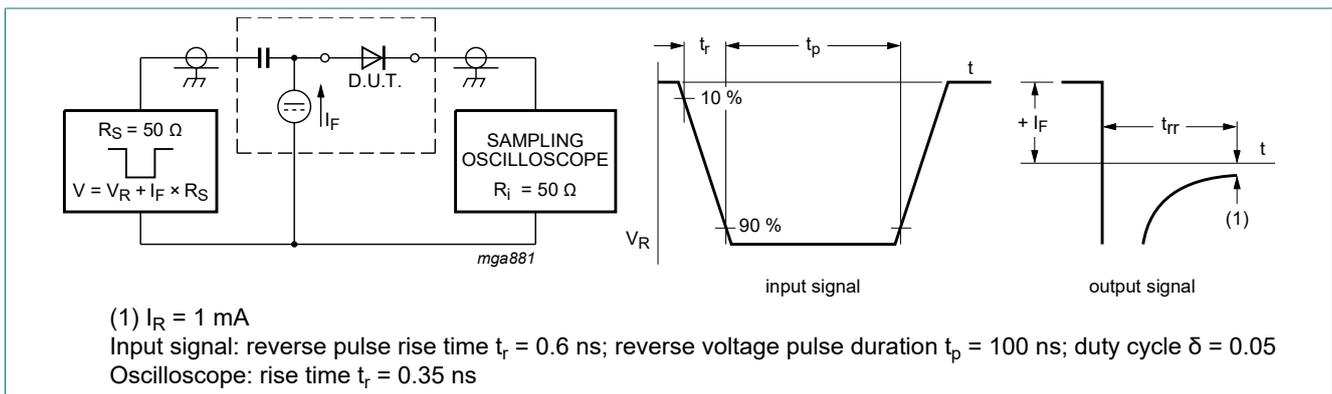


Fig. 8. Reverse recovery time test circuit and waveforms

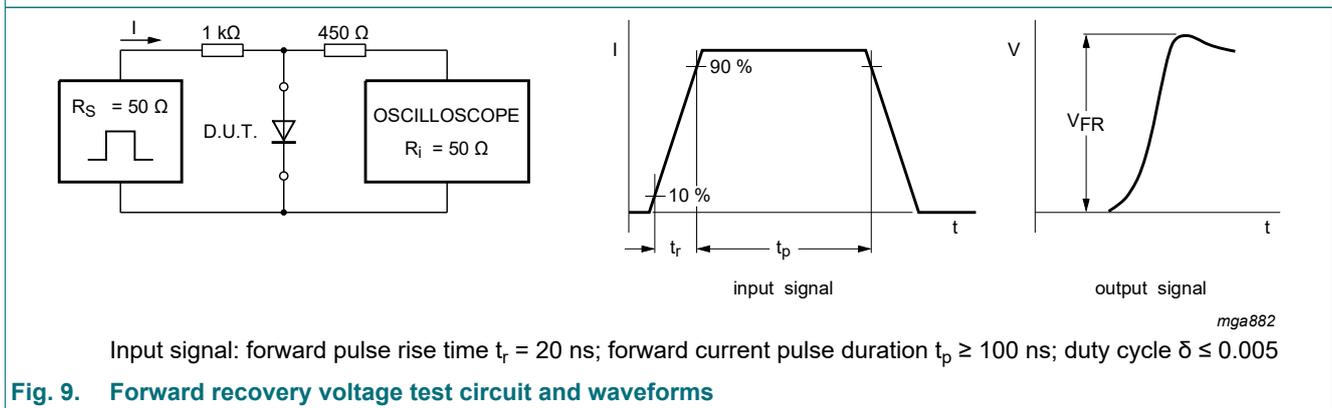


Fig. 9. Forward recovery voltage test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

DFN1412-6: plastic thermal enhanced ultra thin small outline package; no leads;
6 terminals; body: 1.4 x 1.2 x 0.47 mm

SOT1268

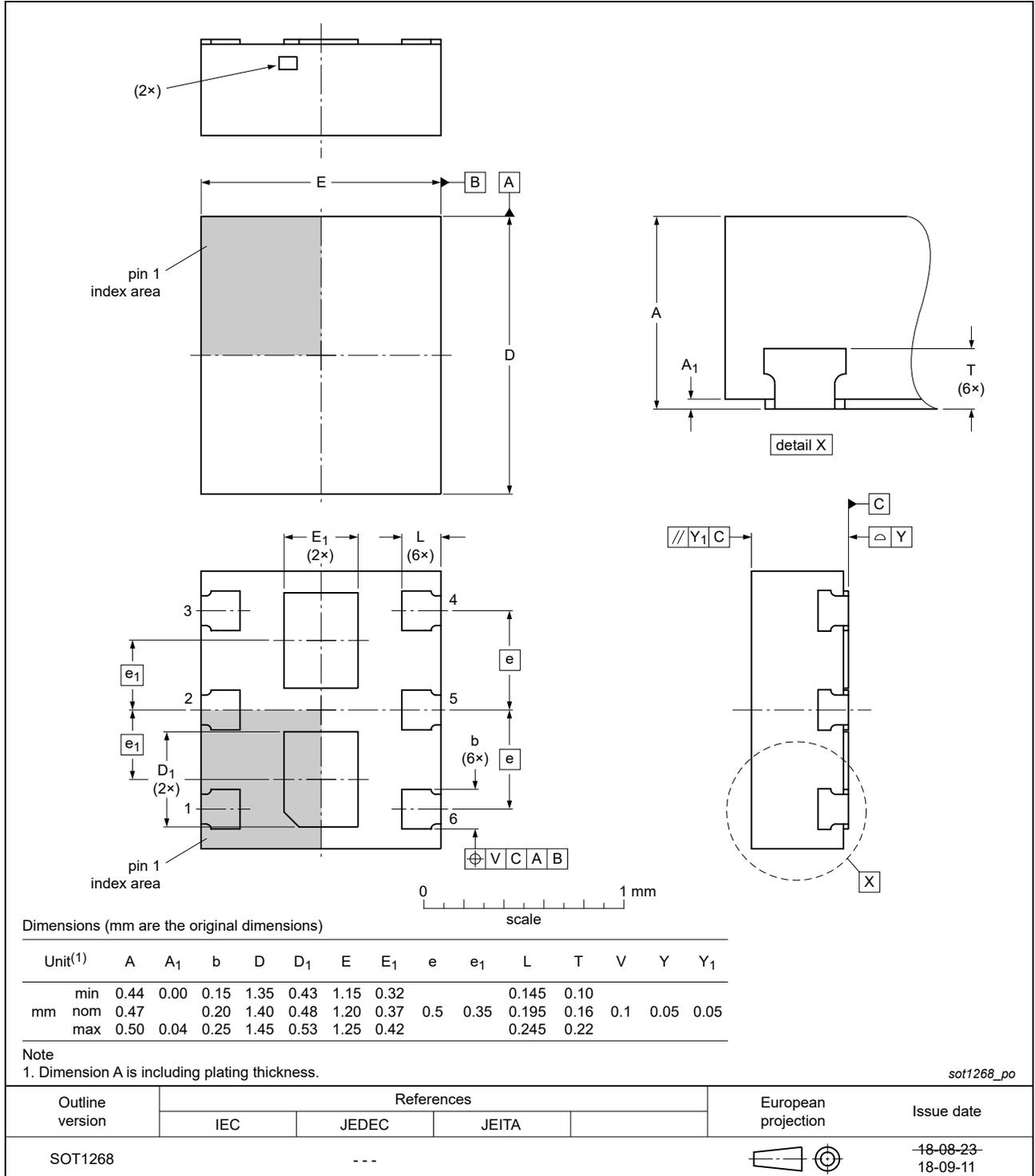


Fig. 10. Package outline DFN1412-6 (SOT1268)

13. Soldering

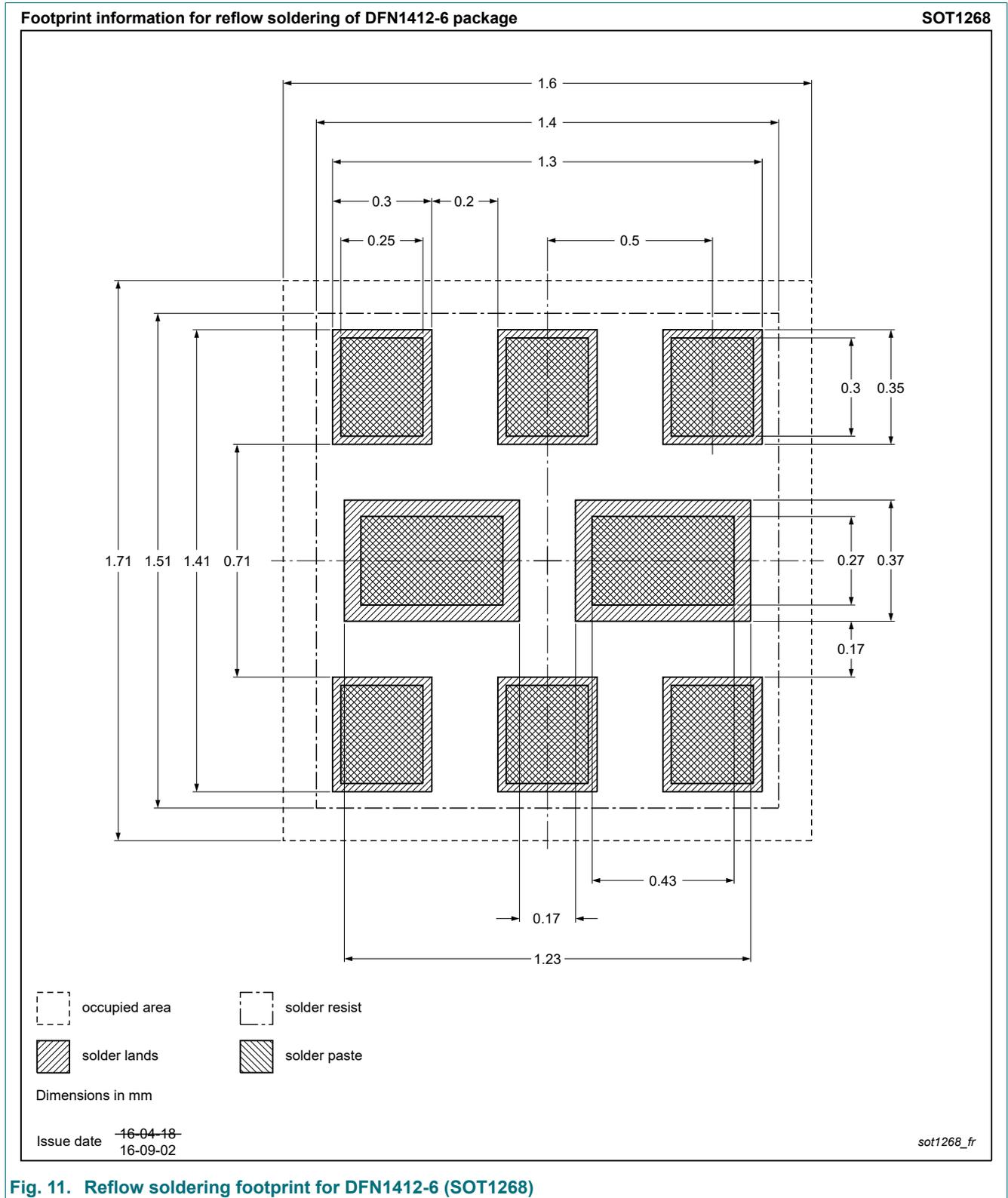


Fig. 11. Reflow soldering footprint for DFN1412-6 (SOT1268)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAW56SRA-Q v.1	20220628	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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